

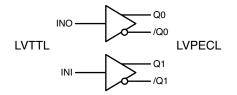
3.3V/5V DUAL LVTTL/LVCMOS-to-DIFFERENTIAL LVPECL TRANSLATOR

Precision Edge[®] SY89322V

FEATURES

- 3.3V and 5V power supply option
- 300ps typical propagation delay
- **■** Differential LVPECL outputs
- PNP LVTTL inputs for minimal loading
- **■** Flow-through pinouts
- Q outputs will default HIGH with inputs open
- Max. frequency range 800MHz
- Available in ultra-small 8-pin MLF® (2mm x 2mm) package

BLOCK DIAGRAM





DESCRIPTION

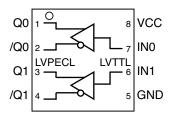
The SY89322V is a dual TTL/CMOS-to-differential PECL translator capable of running from a 3.3V or 5V supply. This part can be used in either LVTTL/LVCMOS/LVPECL or TTL/CMOS/PECL systems.

It requires only a single positive supply of +3.3V or +5V, no negative supply is required.

The SY89322V is functionally equivalent to the SY100EPT22V, but in an ultra-small 8-lead MLF® package that features a 70% smaller footprint. The ultra-small package and the low skew, dual gate design of the SY89322V makes it ideal for those applications where space, performance and low power are at a premium.

Micrel, Inc. SY89322V

PACKAGE/ORDERING INFORMATION



8-Pin MLF®
Ultra-Small Outline (2mm × 2mm)

Ordering Information

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY89322VMITR	MLF-8	Industrial	322V	Sn-Pb
SY89322VMGTR ⁽¹⁾	MLF-8	Industrial 322V with Pb-Free bar-line indicator		Pb-Free NiPdAu

Note:

1. Pb-Free package is recommended for new designs.

PIN DESCRIPTION

Pin Number	Pin Number Pin Name Type		Pin Function			
1, 2, Q0, /Q0, 100k ECL Output 3, 4 Q1, /Q1		100k ECL Output	Differential LVPECL Outputs: Default to LOW if IN input left open. See "Output Interface Applications" section for recommendations on terminations.			
5 GND, Ground Exposed Pad		Ground	GND and exposed pad must be tied to ground plane.			
6, 7	IN1, IN0	TTL/LVTTL Input	Single-ended TTL Inputs.			
8	VCC	Power	Positive Power Supply: Bypass with 0.1μF//0.01μF low ESR capacitors.			

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V _{CC})	0.5V to +6.0V
Input Voltage (V _{IN})	–0.5V to V _{CC}
LVPECL Output Current (I _{OUT})	
Continuous	50mA
Surge	100mA
Input Current	
Source or sink current on IN, /IN	±50mA
Lead Temperature (soldering, 20 sec.).	+260°C
Storage Temperature (T _S)	–65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage (V _{CC})	+3.0V to +3.6V
Ambient Temperature (T _A)	–40°C to +85°C
Package Thermal Resistance ⁽³⁾	
$MLF^{\mathbb{B}}\left(\theta_{JA}\right)$	
Still-Air	93°C/W
500lfpm	87°C/W
$MLF^{ ext{ iny B}}(\Psi_{JB})$	
Junction-to-Board	60°C/W

DC ELECTRICAL CHARACTERISTICS

 $T_{\Delta} = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}$

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{CC}	Power Supply Voltage		3.0 4.5		3.6 5.5	V
I _{CC}	Power Supply Current				25	mA

TTL DC ELECTRICAL CHARACTERISTICS

 V_{CC} = +3.3V ±10% or +5.0V ±10%; T_A = -40°C to +85°C, unless otherwise noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V_{IH}	Input HIGH Voltage		2.0			V
V _{IL}	Input LOW Voltage				0.8	V
I _{IH}	Input HIGH Current	$V_{IN} = 2.7V$ $V_{IN} = V_{CC}$			20 100	μA μA
I _{IL}	Input LOW Current	V _{IN} = 0.5V			-0.2	mA
V _{IK}	Input Clamp Voltage	$I_{IN} = -18mA$			-1.2	V

PECL DC ELECTRICAL CHARACTERISTICS

 V_{CC} = +3.3V ±10% or +5V ±10%; R_L = 50 Ω to V_{CC} -2V; T_A = -40°C to +85°C, unless otherwise noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{OH}	Output HIGH		V _{CC} -1.080		V _{CC} -0.880	V
V_{OL}	Output LOW Voltage		V _{CC} -1.83		V _{CC} -1.550	V

Notes:

- 1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- 3. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.

AC ELECTRICAL CHARACTERISTICS

 $\underline{V_{CC}} = +3.3 V \pm 10\% \text{ or } +5.0 V \pm 10\%; \ R_L = 50 \Omega \text{ to } V_{CC} - 2 V, \ T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}, \ \text{unless otherwise noted}.$

Symbol	Parameter	Condition	Min	Тур	Max	Units
f _{MAX}	Maximum Toggle Frequency				800	MHz
t _{PD}	Propagation Delay IN-to-Q		100		600	ps
t _{SKEW}	Within-Device Skew	Note 4			100	ps
	Part-to-Part Jitter	Note 4			500	ps
t _{Jitter}	Cycle-to-Cycle Jitter	Note 5			2	ps _{RMS}
	Total Jitter	Note 6			25	ps _{PP}
t _r , t _f	Output Rise/Fall Time (20% to 80%)		200		500	ps

Notes:

- 4. Same transition at common $V_{\mbox{\footnotesize CC}}$ levels.
- 5. Cycle-to-cycle jitter definition: The variation of periods between adjacent cycles, T_n T_{n-1}, where T is the time between rising edges of the output signal.
- **6.** Total jitter definition: with an ideal clock input of frequency ≤ f_{MAX}, no more than one output edge in 10¹² output edge will deviate by more than the specified peak-to-peak jitter value.

LVPECL OUTPUT INTERFACE APPLICATIONS

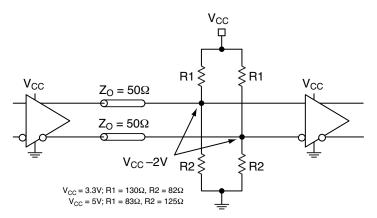


Figure 1a. Parallel Thevenin-Equivalent Termination

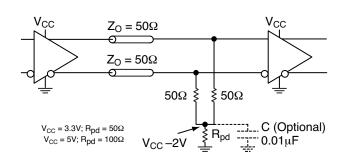
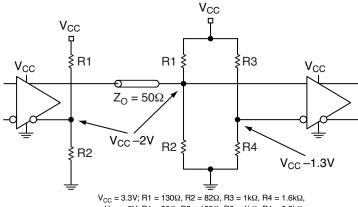


Figure 1b. Three Resistor "Y Termination"

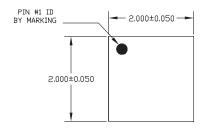


 $V_{CC} = 5.5V$, $R1 = 130\Omega$, $R2 = 62\Omega$, $R3 = 18\Omega$, $R4 = 1.08\Omega$, $V_{CC} = 5V$; $R1 = 83\Omega$, $R2 = 125\Omega$, $R3 = 18\Omega$, $R4 = 2.88\Omega$,

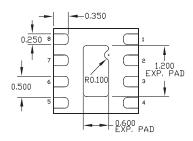
Figure 1c. Terminating Unused I/O

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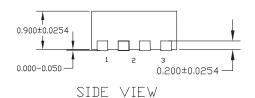
8-PIN ULTRA-SMALL EPAD-MicroLeadFrame® (MLF-8)



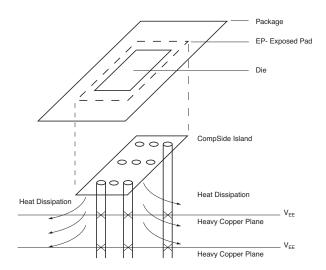
TOP VIEW



BOTTOM VIEW



ALL DIMENSIONS ARE IN MILLIMETERS.
MAX. PACKAGE WARPAGE IS 0.05 mm.
MAXIMM ALLOWABE BURRS IS 0.076 mm IN ALL DIRECTIONS.
PIN #1 ID ON TOP WILL BE LASER/INK MARKED.



PCB Thermal Consideration for 8-Pin MLF® Package

Package Notes:

- 1. Package meets Level 2 qualification.
- 2. All parts are dry-packaged before shipment.
- 3. Exposed pads must be soldered to a ground for proper thermal management.

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131

TEL + 1 (408) 944-0800 FAX + 1 (408) 474-1000 WEB http://www.micrel.com

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